

UF630

Power MOSFET

200V, 9A N-CHANNEL
POWER MOSFET

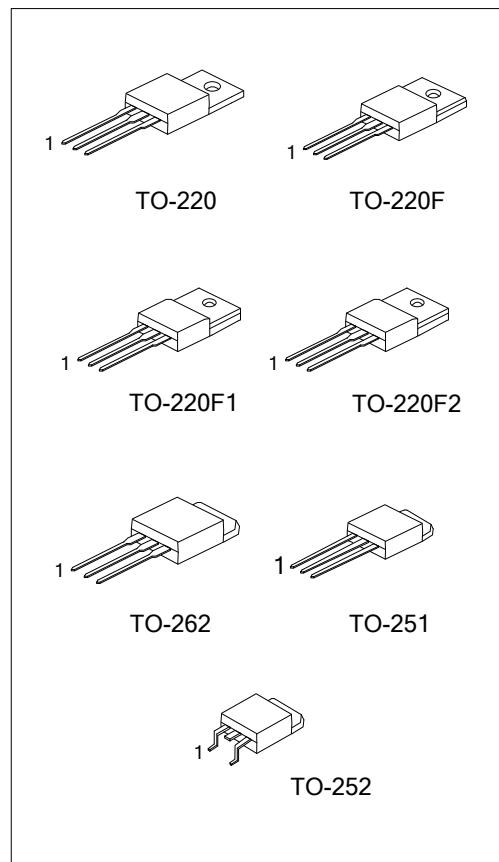
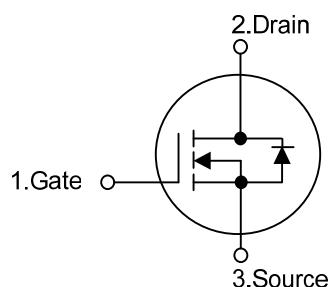
■ DESCRIPTION

The N-Channel enhancement mode silicon gate power MOSFET is designed for high voltage, high speed power switching applications such as switching regulators, switching converters, solenoid, motor drivers, relay drivers.

■ FEATURES

- * $R_{DS(ON)} = 0.4\Omega$ @ $V_{GS} = 10$ V
- * Ultra Low Gate Charge (typical 19 nC)
- * Low Reverse Transfer Capacitance (C_{RSS} = typical 80 pF)
- * Fast Switching Capability
- * Avalanche Energy Specified
- * Improved dv/dt Capability

■ SYMBOL



■ ORDERING INFORMATION

Ordering Number		Package	Pin Assignment			Packing
Lead Free	Halogen Free		1	2	3	
UF630L-TA3-T	UF630G-TA3-T	TO-220	G	D	S	Tube
UF630L-TF1-T	UF630G-TF1-T	TO-220F1	G	D	S	Tube
UF630L-TF2-T	UF630G-TF2-T	TO-220F2	G	D	S	Tube
UF630L-TF3-T	UF630G-TF3-T	TO-220F	G	D	S	Tube
UF630L-T2Q-T	UF630G-T2Q-T	TO-262	G	D	S	Tube
UF630L-TM3-T	UF630G-TM3-T	TO-251	G	D	S	Tube
UF630L-TN3-R	UF630G-TN3-R	TO-252	G	D	S	Tape Reel
UF630L-TN3-T	UF630G-TN3-T	TO-252	G	D	S	Tube

Note: Pin Assignment: G: Gate D: Drain S: Source

 UF630L-TA3-T	(1)R: Tape Reel, T: Tube
	(2) TA3: TO-220, TF1: TO-220F1, TF2: TO-220F2, TF3: TO-220F, T2Q: TO-262, TM3: TO-251, TN3: TO-252
	(3)L: Lead Free, G: Halogen Free

■ ABSOLUTE MAXIMUM RATINGS ($T_c = 25^\circ\text{C}$, unless otherwise specified)

PARAMETER	SYMBOL	RATINGS	UNIT
Drain-Source Voltage	V_{DSS}	200	V
Drain-Gate Voltage ($R_{GS} = 20\text{k}\Omega$, $T_J = 25^\circ\text{C} \sim 125^\circ\text{C}$)	V_{DGR}	200	V
Gate-Source Voltage	V_{GSS}	± 20	V
Continuous Drain Current	I_D	9	A
Pulsed Drain Current (Note 2)	I_{DM}	36	A
Single Pulse Avalanche Energy (Note 3)	E_{AS}	150	mJ
Power Dissipation	TO-220/TO-262	P_D	W
	TO-220F1/ TO-220F		
	TO-220F2		
	TO-251/ TO-252		
Junction Temperature	T_J	+150	$^\circ\text{C}$
Storage Temperature	T_{STG}	-55 ~ +150	$^\circ\text{C}$

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged.

Absolute maximum ratings are stress ratings only and functional device operation is not implied.

2. Repetitive Rating : Pulse width limited by T_J

3. L = 4mH, $I_{AS} = 8.3\text{A}$, $V_{DD} = 20\text{V}$, $R_G = 25 \Omega$, Starting $T_J = 25^\circ\text{C}$

■ THERMAL DATA

PARAMETER	SYMBOL	RATING	UNIT
Junction to Ambient	θ_{JA}	62.5	$^\circ\text{C/W}$
		100.3	
Junction to Case	θ_{JC}	1.71	$^\circ\text{C/W}$
		3.31	
		2.98	
		2.7	

■ ELECTRICAL SPECIFICATIONS ($T_c = 25^\circ\text{C}$, unless otherwise specified)

PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
OFF CHARACTERISTICS						
Drain-Source Breakdown Voltage	BV_{DSS}	$V_{\text{GS}} = 0\text{V}, I_{\text{D}} = 250\mu\text{A}$	200			V
On-State Drain Current (Note 1)	$I_{\text{D}(\text{ON})}$	$V_{\text{DS}} > I_{\text{D}(\text{ON})} \times R_{\text{DS}(\text{ON})\text{MAX}}, V_{\text{GS}} = 10\text{V}$	9			A
Drain-Source Leakage Current	I_{DSS}	$V_{\text{DS}} = \text{Rated } \text{BV}_{\text{DSS}}, V_{\text{GS}} = 0\text{V}$		10		μA
Gate-Source Leakage Current	Forward	$V_{\text{GS}} = 20\text{V}, V_{\text{DS}} = 0\text{V}$		100		nA
	Reverse	$V_{\text{GS}} = -20\text{V}, V_{\text{DS}} = 0\text{V}$		-100		nA
ON CHARACTERISTICS						
Gate Threshold Voltage	$V_{\text{GS}(\text{TH})}$	$V_{\text{GS}} = V_{\text{DS}}, I_{\text{D}} = 250\mu\text{A}$	2		4	V
Static Drain-Source On-State Resistance	$R_{\text{DS}(\text{ON})}$	$V_{\text{GS}} = 10\text{V}, I_{\text{D}} = 5\text{A}$		0.25	0.4	Ω
DYNAMIC CHARACTERISTICS						
Input Capacitance	C_{ISS}	$V_{\text{DS}} = 25\text{V}, V_{\text{GS}} = 0\text{V}, f = 1.0\text{MHz}$		600		pF
Output Capacitance	C_{OSS}			250		pF
Reverse Transfer Capacitance	C_{RSS}			80		pF
SWITCHING CHARACTERISTICS						
Turn-On Delay Time	$t_{\text{D}(\text{ON})}$	$V_{\text{DD}} = 90\text{V}, I_{\text{D}} \approx 9\text{A}, R_{\text{GS}} = 9.1\Omega, V_{\text{GS}} = 10\text{V}, R_{\text{L}} = 9.6\Omega$ (Note 1, 2)			30	ns
Turn-On Rise Time	t_{R}				50	ns
Turn-Off Delay Time	$t_{\text{D}(\text{OFF})}$				50	ns
Turn-Off Fall Time	t_{F}				40	ns
Total Gate Charge	Q_{G}	$V_{\text{GS}} = 10\text{V}, I_{\text{D}} = 9\text{A}, V_{\text{DS}} = 0.8 \times \text{Rated } \text{BV}_{\text{DSS}}$		19	30	nC
Gate-Source Charge	Q_{GS}			10		nC
Gate-Drain Charge	Q_{GD}			9		μC
DRAIN-SOURCE DIODE CHARACTERISTICS AND MAXIMUM RATINGS						
Drain-Source Diode Forward Voltage	V_{SD}	$V_{\text{GS}} = 0\text{V}, I_{\text{S}} = 9.0\text{A}$			2	V
Maximum Continuous Drain-Source Diode Forward Current	I_{S}				9	A
Maximum Pulsed Drain-Source Diode Forward Current	I_{SM}				36	A
Reverse Recovery Time	t_{rr}	$I_{\text{S}} = 9.0\text{A}, dI_{\text{S}}/dt = 100\text{A}/\mu\text{s}$ (Note 1)		450		ns
Reverse Recovery Charge	Q_{RR}			3		μC

Notes: 1. Pulse Test: Pulse width $\leq 300\mu\text{s}$, Duty cycle $\leq 2\%$

2. Essentially independent of operating temperature

■ TEST CIRCUITS AND WAVEFORMS

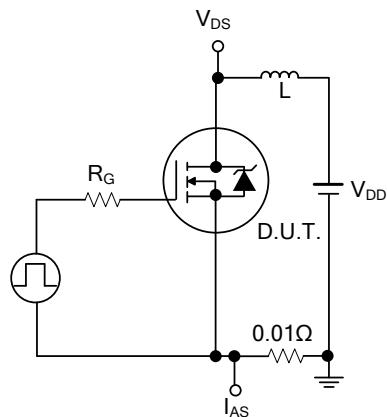


Fig.1 Unclamped Energy Test Circuit

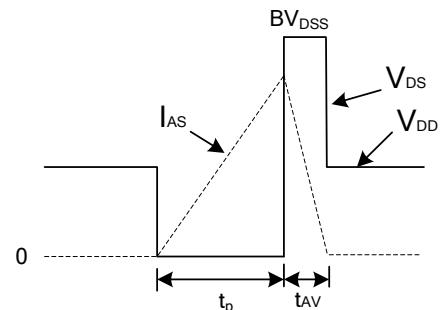


Fig.2 Unclamped Energy Waveforms

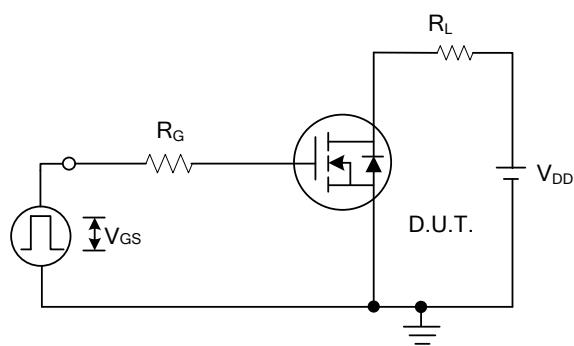


Fig.3 Switching Time Test Circuit

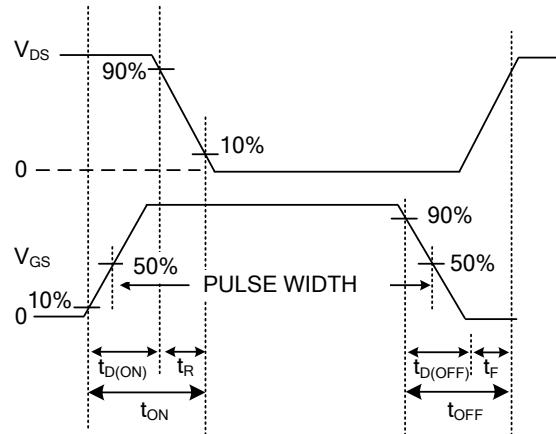


Fig.4 Resistive Switching Waveforms

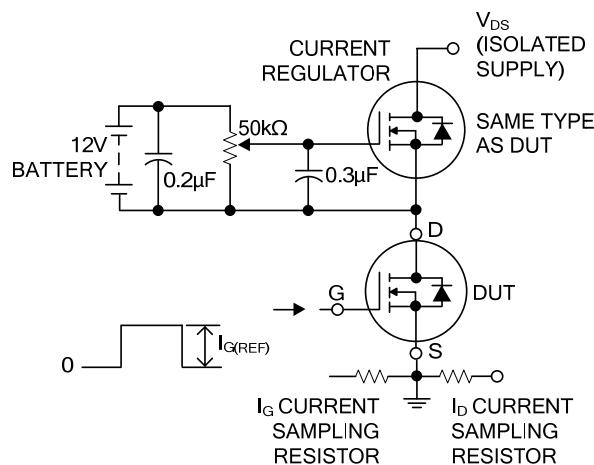


Fig.5 Gate Charge Test Circuit

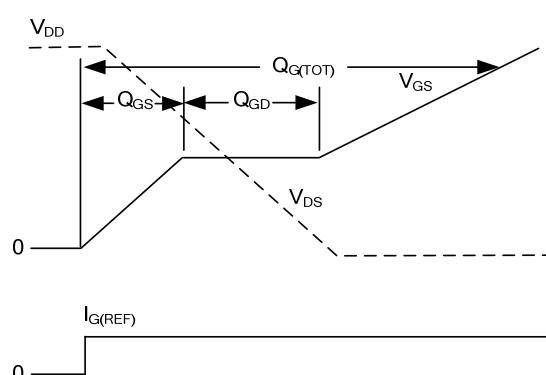
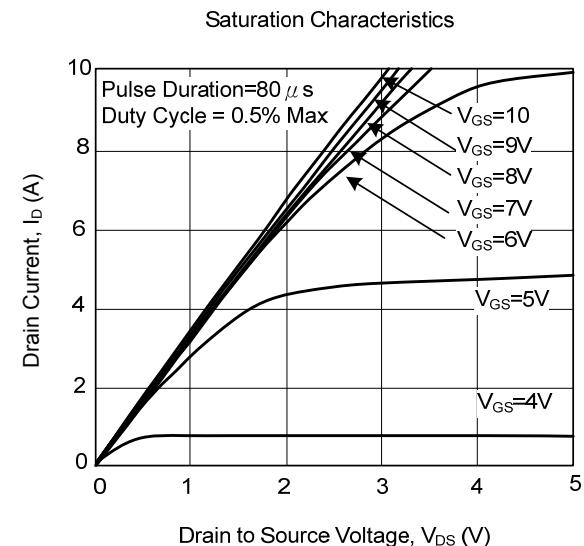
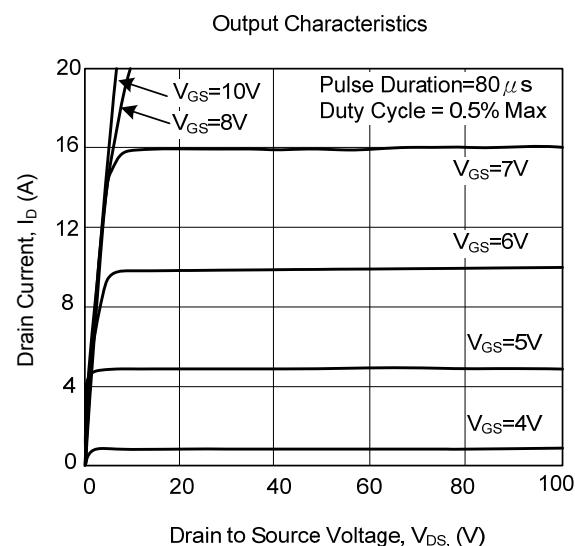
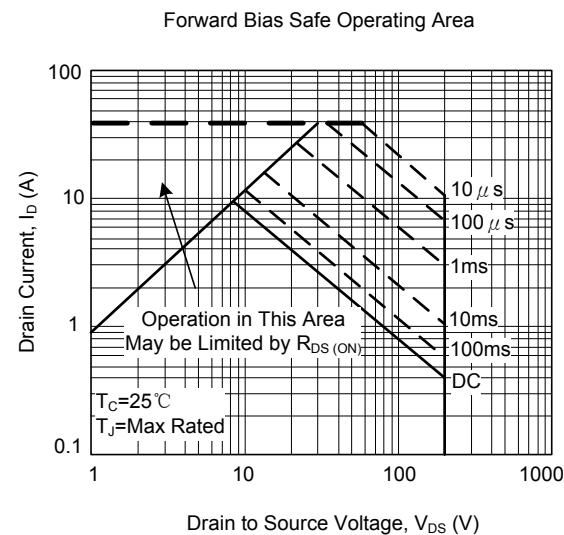
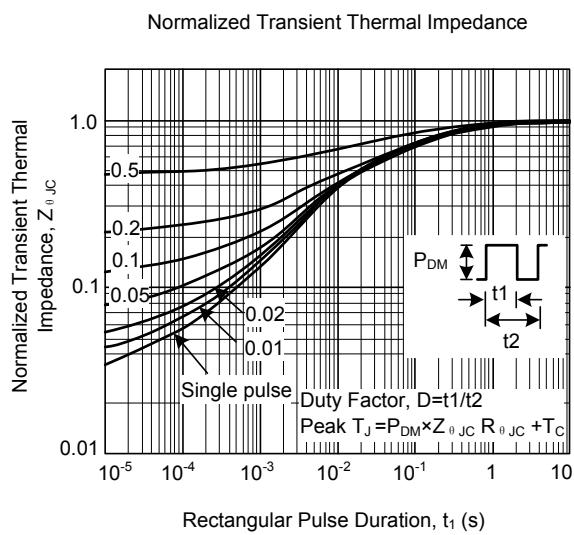
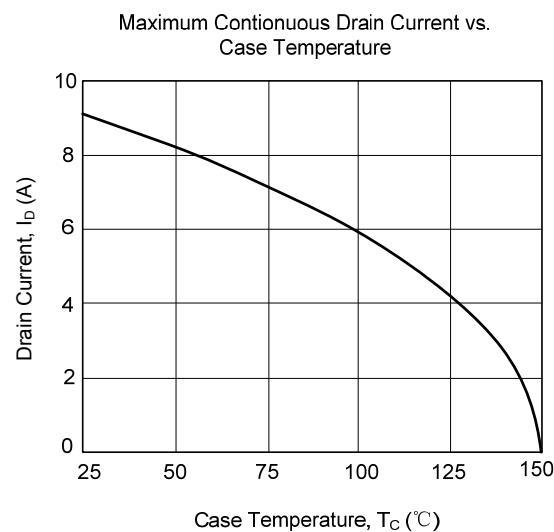
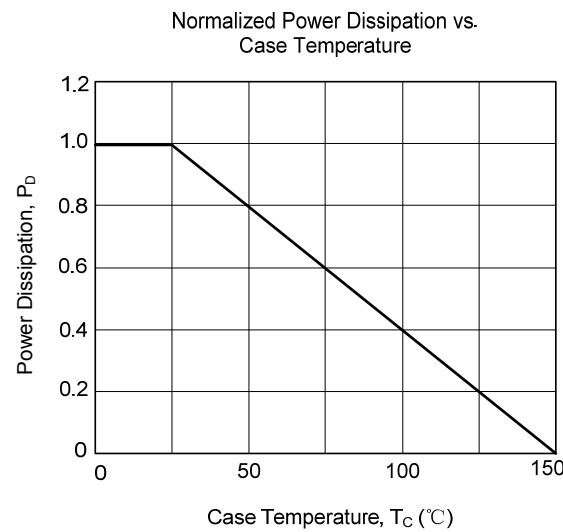
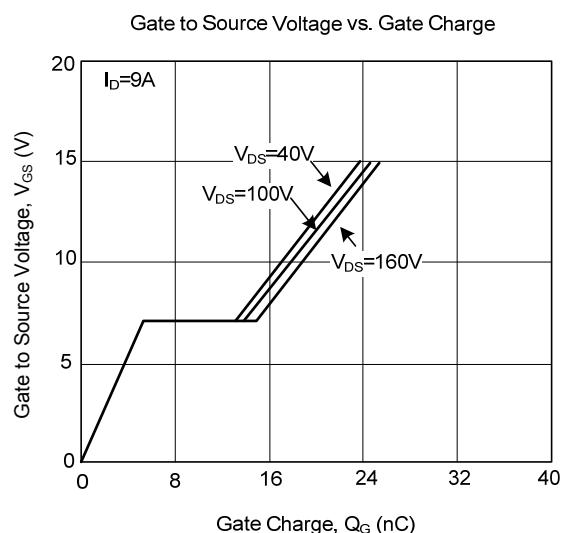
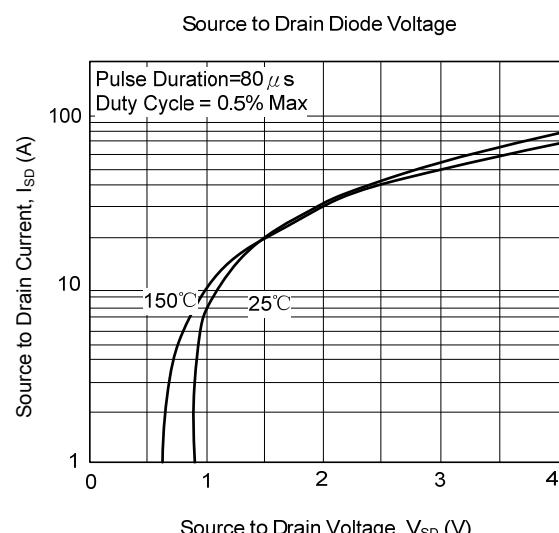
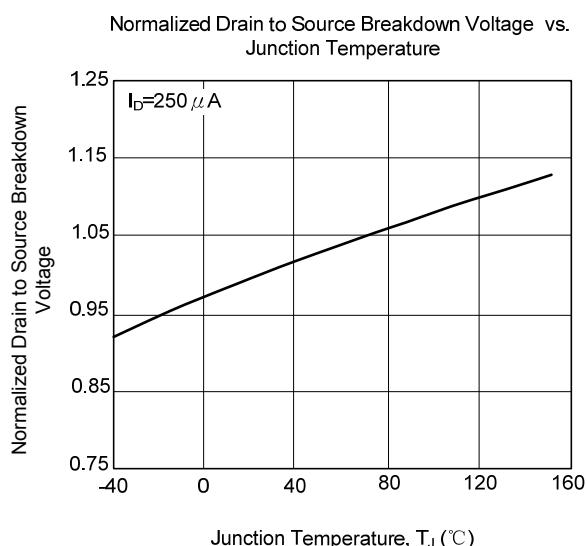
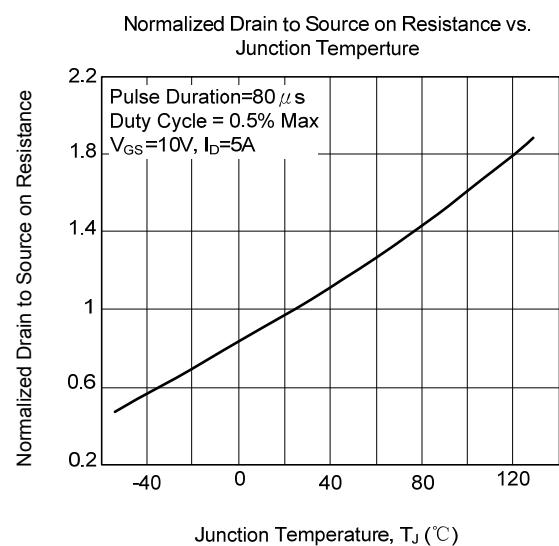
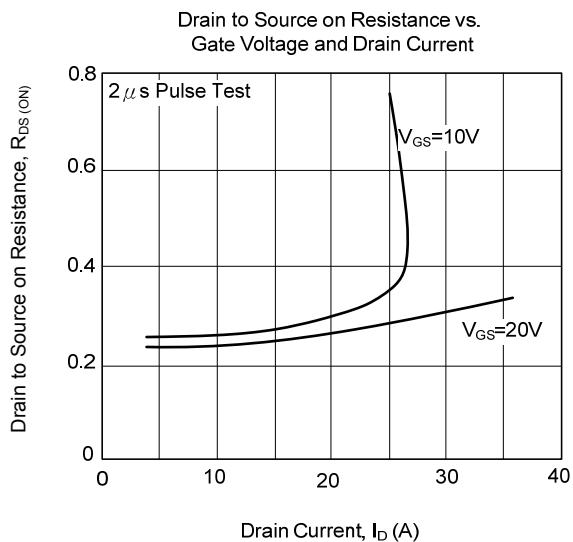
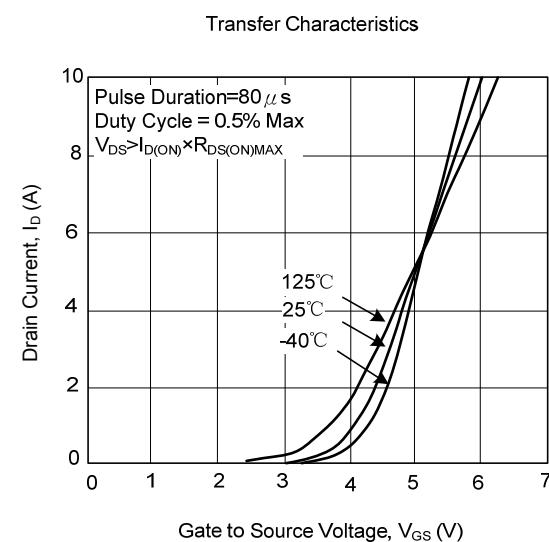


Fig.6 Gate Charge Waveforms

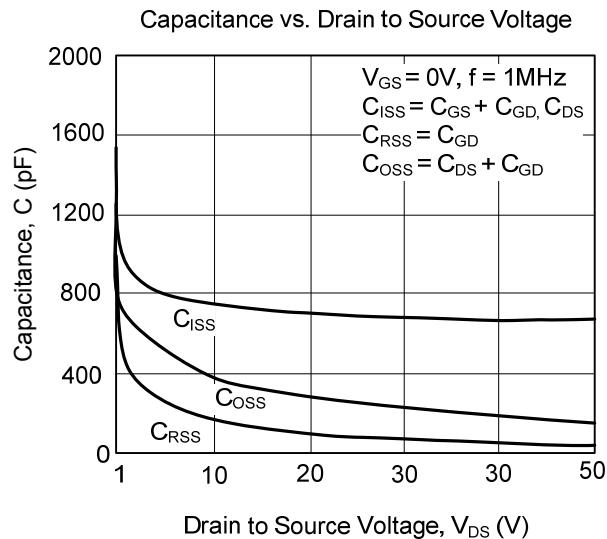
■ TYPICAL CHARACTERISTICS



■ TYPICAL CHARACTERISTICS (Cont.)



■ TYPICAL CHARACTERISTICS (Cont.)



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